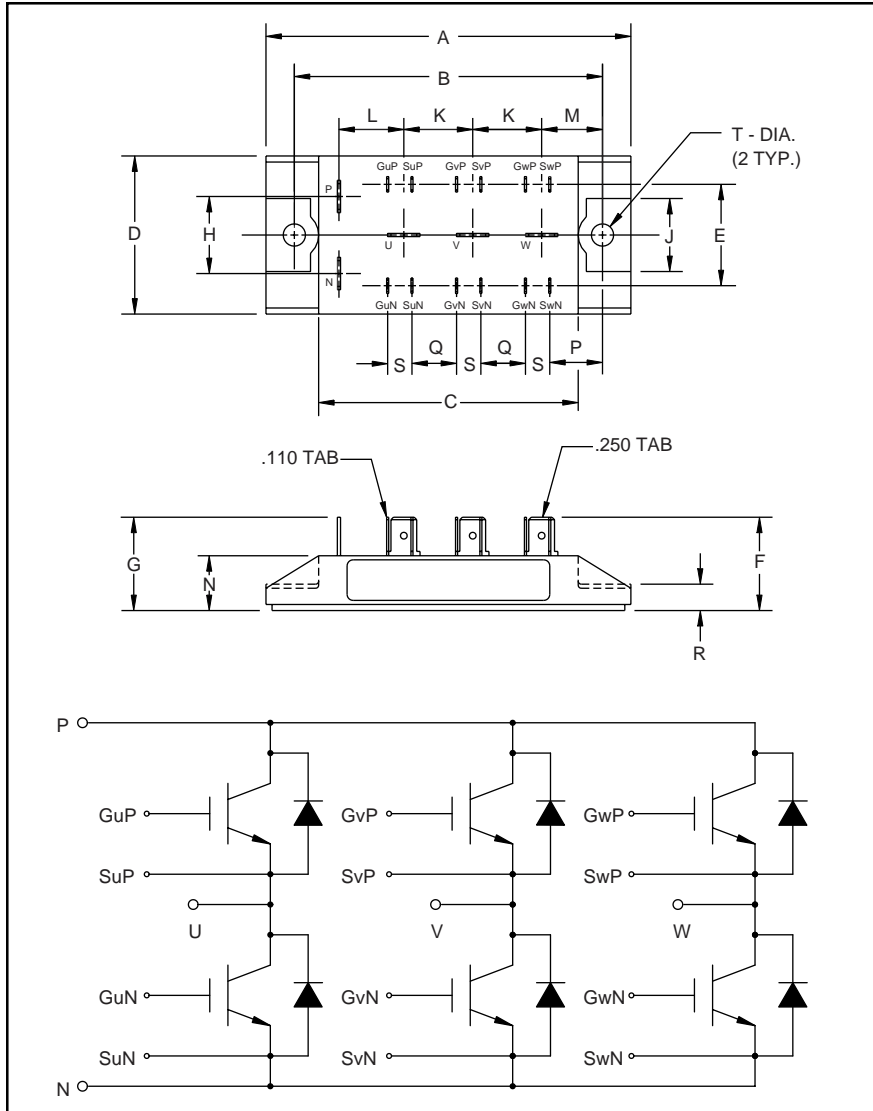


### Six-IGBT IGBTMOD™ H-Series Module 15 Amperes/600 Volts



Outline Drawing and Circuit Diagram

Dimensions	Inches	Millimeters
A	3.54	90.0
B	2.99±0.01	76.0±0.2
C	2.52	64.0
D	1.54	39.0
E	0.98	25.0
F	0.90	23.0
G	0.87	22.0
H	0.75	19.0
J	0.71	18.0

Dimensions	Inches	Millimeters
K	0.67	17.0
L	0.63	16.0
M	0.59	15.0
N	0.56	14.1
P	0.51	13.0
Q	0.43	11.0
R	0.26	6.5
S	0.24	6.0
T	0.22 Dia.	Dia. 5.5



#### Description:

Powerex IGBTMOD™ Modules are designed for use in switching applications. Each module consists of six IGBT Transistors in a three phase bridge configuration, with each transistor having a reverse-connected super-fast recovery free-wheel diode. All components and interconnects are isolated from the heat sinking baseplate, offering simplified system assembly and thermal management.

#### Features:

- Low Drive Power
- Low  $V_{CE(sat)}$
- Discrete Super-Fast Recovery (70ns) Free-Wheel Diode
- High Frequency Operation (20-25kHz)
- Isolated Baseplate for Easy Heat Sinking

#### Applications:

- AC Motor Control
- Motion/Servo Control
- UPS
- Welding Power Supplies
- Laser Power Supplies

#### Ordering Information:

Example: Select the complete part module number you desire from the table below -i.e. CM15TF-12H is a 600V ( $V_{CES}$ ), 15 Ampere Six-IGBT IGBTMOD™ Power Module.

Type	Current Rating Amperes	$V_{CES}$ Volts (x 50)
CM	15	12

**CM15TF-12H**  
**Six-IGBT IGBTMOD™ H-Series Module**  
 15 Amperes/600 Volts

**Absolute Maximum Ratings,  $T_j = 25\text{ }^\circ\text{C}$  unless otherwise specified**

Ratings	Symbol	CM15TF-12H	Units
Junction Temperature	$T_j$	-40 to +150	$^\circ\text{C}$
Storage Temperature	$T_{stg}$	-40 to +125	$^\circ\text{C}$
Collector-Emitter Voltage (G-E SHORT)	$V_{CES}$	600	Volts
Gate-Emitter Voltage	$V_{GES}$	$\pm 20$	Volts
Collector Current	$I_C$	15	Amperes
Peak Collector Current	$I_{CM}$	30*	Amperes
Diode Forward Current	$I_F$	15	Amperes
Diode Forward Surge Current	$I_{FM}$	30*	Amperes
Power Dissipation	$P_d$	100	Watts
Max. Mounting Torque M5 Mounting Screws	-	17	in-lb
Module Weight (Typical)	-	150	Grams
V Isolation	$V_{RMS}$	2500	Volts

\* Pulse width and repetition rate should be such that device junction temperature does not exceed the device rating.

**Static Electrical Characteristics,  $T_j = 25\text{ }^\circ\text{C}$  unless otherwise specified**

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Collector-Cutoff Current	$I_{CES}$	$V_{CE} = V_{CES}, V_{GE} = 0V$	-	-	1.0	mA
Gate Leakage Current	$I_{GES}$	$V_{GE} = V_{GES}, V_{CE} = 0V$	-	-	0.5	$\mu\text{A}$
Gate-Emitter Threshold Voltage	$V_{GE(th)}$	$I_C = 1.5\text{mA}, V_{CE} = 10V$	4.5	6.0	7.5	Volts
Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	$I_C = 15A, V_{GE} = 15V$	-	2.1	2.8**	Volts
		$I_C = 15A, V_{GE} = 15V, T_j = 150^\circ\text{C}$	-	2.15	-	Volts
Total Gate Charge	$Q_G$	$V_{CC} = 300V, I_C = 15A, V_{GS} = 15V$	-	45	-	nC
Diode Forward Voltage	$V_{FM}$	$I_E = 15A, V_{GS} = 0V$	-	-	2.8	Volts

\*\* Pulse width and repetition rate should be such that device junction temperature rise is negligible.

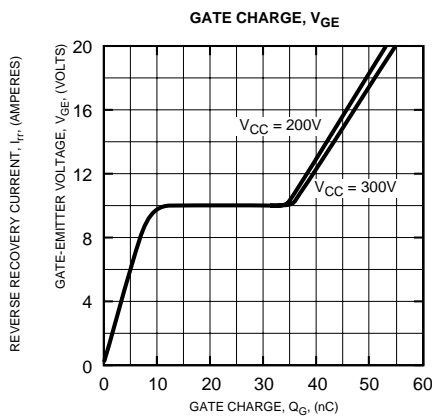
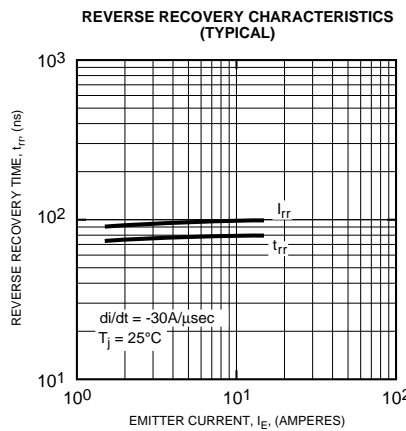
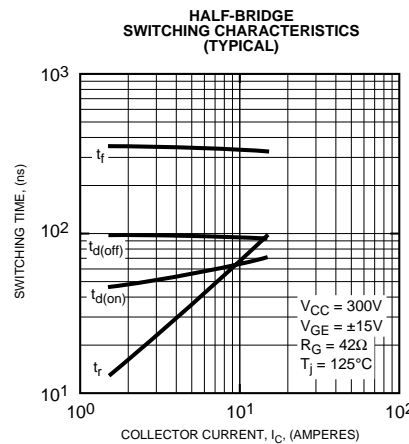
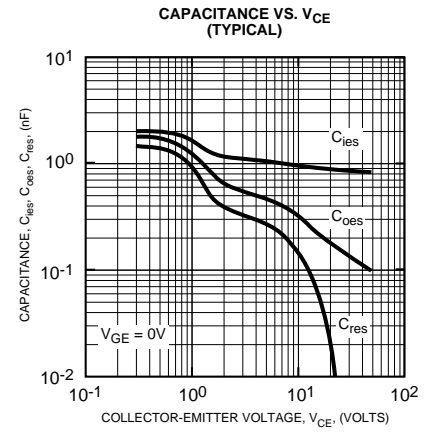
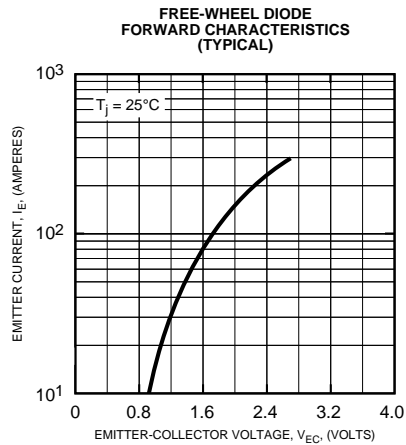
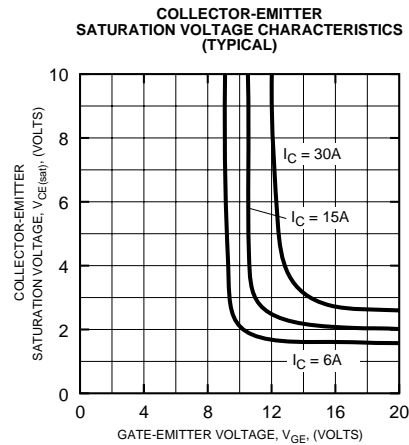
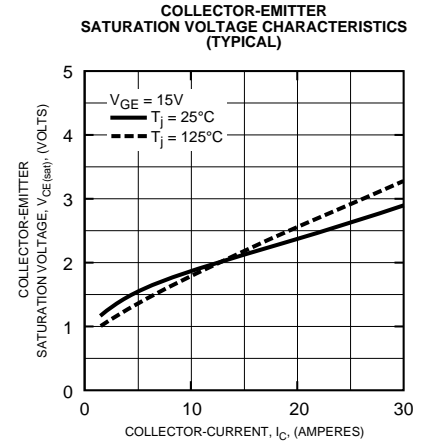
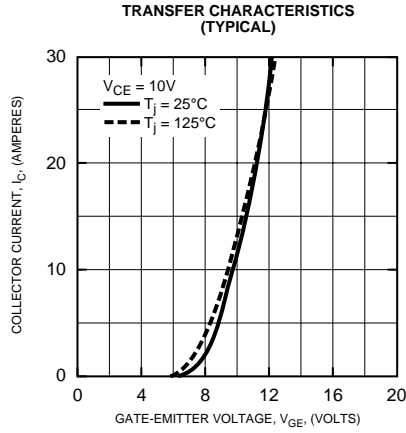
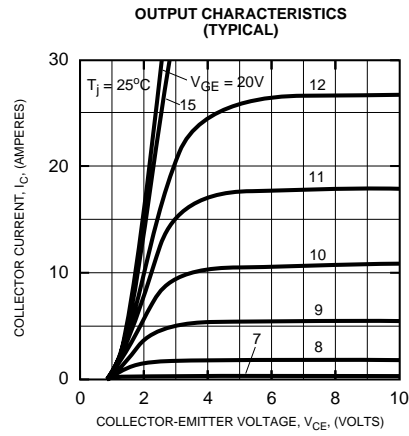
**Dynamic Electrical Characteristics,  $T_j = 25\text{ }^\circ\text{C}$  unless otherwise specified**

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units	
Input Capacitance	$C_{ies}$		-	-	1.5	nF	
Output Capacitance	$C_{oes}$	$V_{GE} = 0V, V_{CE} = 10V, f = 1\text{MHz}$	-	-	0.5	nF	
Reverse Transfer Capacitance	$C_{res}$		-	-	0.3	nF	
Resistive	Turn-on Delay Time	$t_{d(on)}$	-	-	120	ns	
							Load
Switch	Turn-off Delay Time	$t_{d(off)}$	-	-	200	ns	
							Times
Diode Reverse Recovery Time	$t_{rr}$	$I_E = 15A, di_E/dt = -30A/\mu\text{s}$	-	-	110	ns	
Diode Reverse Recovery Charge	$Q_{rr}$	$I_E = 15A, di_E/dt = -30A/\mu\text{s}$	-	0.04	-	$\mu\text{C}$	

**Thermal and Mechanical Characteristics,  $T_j = 25\text{ }^\circ\text{C}$  unless otherwise specified**

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Thermal Resistance, Junction to Case	$R_{th(j-c)}$	Per IGBT	-	-	1.30	$^\circ\text{C/W}$
Thermal Resistance, Junction to Case	$R_{th(j-c)}$	Per FWDi	-	-	3.50	$^\circ\text{C/W}$
Contact Thermal Resistance	$R_{th(c-f)}$	Per Module, Thermal Grease Applied	-	-	0.092	$^\circ\text{C/W}$

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